## G3VM-62C1/F1

**MOS FET Relays** 

# Analog-switching MOS FET Relays for High Switching Currents, with Dielectric Strength of 2.5 kVAC between I/O.

- New 2-channel model included in the 60-V load voltage series.
- Switches minute analog signals.
- Dielectric strength of 2,500 Vrms between I/O.
- Surface-mounting models included in series.

**RoHS** compliant

### **■** Application Examples

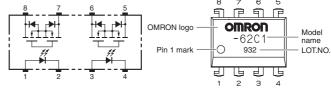
- Test & Measurement equipment
- Security equipment





Note: The actual product is marked differently from the image shown here.

#### **■** Terminal Arrangement/Internal Connections



Note: The actual product is marked differently from the image shown here.

#### **■ List of Models**

Package type	Contact form	Terminals	Load voltage	Model	Minimum package quantity	
rackage type			(peak value) *	Model	Number per tube	Number per tape and reel
	2a (DPST-NO)	PCB Terminals		G3VM-62C1	50	-
DIP8		Surface-mounting Terminals	60 V	G3VM-62F1	50	
				G3VM-62F1(TR)	-	1,500

<sup>\*</sup> The AC peak and DC value are given for the load voltage.

### ■ Absolute Maximum Ratings (Ta = 25°C)

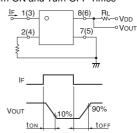
	Item	Symbol	Rating	Unit	Measurement conditions
	LED forward current	lF	50	mA	
<b>±</b>	Repetitive peak LED forward current	IFP	1	Α	100 μs pulses, 100 pps
Input	LED forward current reduction rate	ΔIF/°C	-0.5	mA/°C	Ta ≥ 25°C
=	LED reverse voltage	VR	5	٧	
	Connection temperature	ТJ	125	°C	
	Load voltage (AC peak/DC)	Voff	60	٧	
b	Continuous load current (AC peak/DC)	lo	500	mA	
Output	ON current reduction rate	∆lo/°C	-5.0	mA/°C	Ta ≥ 25°C
	Connection temperature	TJ	125	°C	
Diele	ctric strength between I/O (See note 1.)	strength between I/O (See note 1.) VI-O 2500 Vrms AC for 1 min		AC for 1 min	
Aml	pient operating temperature	Ta	-40 to +85	°C	With no icing or condensation
Ambient storage temperature		Tstg	-55 to +125	°C	With no icing or condensation
Sol	dering temperature	-	260	°C	10 s

Note: 1. The dielectric strength between the input and output was checked by applying voltage between all pins as a group on the LED side and all pins as a group on the light-receiving side.

#### **■ Electrical Characteristics** (Ta = 25°C)

Item		Symbol	Minimum	Typical	Maximum	Unit	Measurement conditions
Input	LED forward voltage	VF	1.0	1.15	1.3	V	IF = 10 mA
	Reverse current	lr	-	-	10	μА	VR = 5 V
	Capacity between terminals	Ст	-	30	-	pF	V = 0, f = 1 MHz
	Trigger LED forward current	IFT	-	1.6	3	mA	Io = 500 mA
Output	Maximum resistance with output ON	Ron	-	1.0	2.0	Ω	IF = 5 mA, Io = 500 mA
	Current leakage when the relay is open	ILEAK	-	-	1.0	μА	Voff = 60 V
	Capacity between terminals	Coff	-	130	-	pF	V = 0, f = 1 MHz
Capacity between I/O terminals		C <sub>I</sub> -o	-	0.8	-	pF	f = 1 MHz, Vs = 0 V
Insulation resistance between I/O terminals		Rı-o	1000	-	-	МΩ	Vi-o = 500 VDC, RoH ≤ 60%
Turn-ON time		ton	-	0.8	2.0	ms	IF = 5 mA, RL = 200 $\Omega$ ,
Turn-OFF time		toff	-	0.1	0.5	ms	V <sub>DD</sub> = 20 V(See note 2.)

Note: 2. Turn-ON and Turn-OFF Times



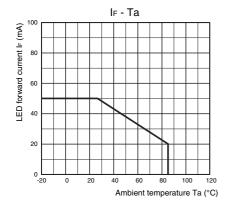
#### **■** Recommended Operating Conditions

Use the G3VM under the following conditions so that the Relay will operate properly.

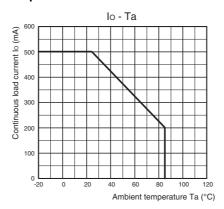
Item	Symbol	Minimum	Typical	Maximum	Unit
Load voltage (AC peak/DC)	V <sub>DD</sub>	-	-	48	V
Operating LED forward current	lF	5	7.5	25	mA
Continuous load current (AC peak/DC)	lo	-	-	500	mA
Ambient operating temperature	Ta	-20	-	65	°C

### **■** Engineering Data

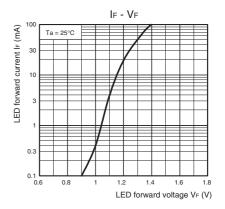
### LED forward current vs. Ambient temperature



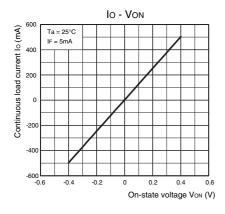
### Continuous load current vs. Ambient temperature



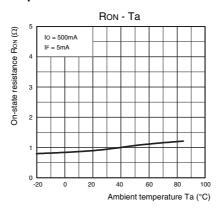
### LED forward current vs. LED forward voltage



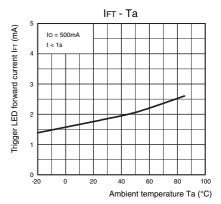
### Continuous load current vs. On-state voltage



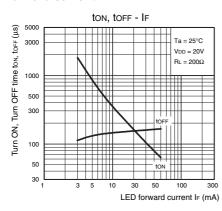
### On-state resistance vs. Ambient temperature



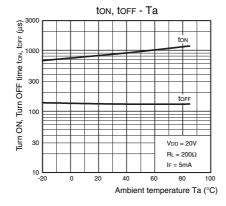
Trigger LED forward current vs. Ambient temperature



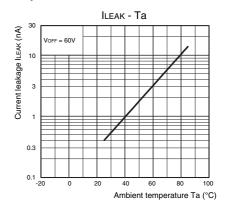
### Turn ON, Turn OFF time vs. LED forward current



Turn ON, Turn OFF time vs. Ambient temperature



### Current leakage vs. Ambient temperature



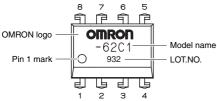
#### **■** Safety Precautions

• Refer to "Common Precautions" for all G3VM models.

### **■** Appearance

#### DIP (Dual Inline Package)

DIP8

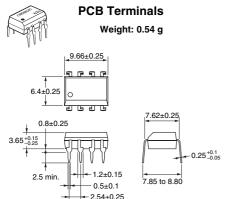


Note: The actual product is marked differently from the image shown here.

### ■ Dimensions (Unit:mm)

**Surface-mounting Terminals** 

10.0 max.



Note: The actual product is marked differently from the

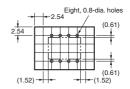
image shown here.

Weight: 0.54 g

-1.2±0.15 1.0 min.

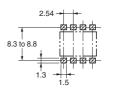
2.54±0.25

PCB Dimensions (BOTTOM VIEW)



#### **Actual Mounting Pad Dimensions**

(Recommended Value, TOP VIEW)



Note: Do not use this document to operate the Unit.

**OMRON Corporation** 

ELECTRONIC AND MECHANICAL COMPONENTS COMPANY Contact: www.omron.com/ecb

Cat. No. K145-E1-01 0412(0412)(O)

Application examples provided in this document are for reference only. In actual applications, confirm equipment functions and safety before using the product.

<sup>•</sup> Consult your OMRON representative before using the product under conditions which are not described in the manual or applying the product to nuclear control systems, railroad systems, aviation systems, vehicles, combustion systems, medical equipment, amusement machines, safety equipment, and other systems or equipment that may have a serious influence on lives and property if used improperty. Make sure that the ratings and performance characteristics of the product provide a margin of safety for the system or equipment, and be sure to provide the system or equipment with double safety mechanisms.